	© Co	terial Compo pyright 2005. IPC, Bannoc nternational and Pan-Ameri	kburn, Illinois	. All rights reserve	tion with lower	level pa	rts, the	declaratio	n encoi	mpasses all lo		erials for	which t	e item is an assembly he manufacturer has declaration.
1752-2 1.1	rd	Form Distri	Type * bute		Declaration Class * Class 6 - RoHS Yes/No, Homogeneous Materials and Mfg Inform									
Supplier Information														
Company Name *		Company Unique ID		Unique ID Au	Ithority	Respor	nse Date) *		Response Do	ocument ID			
SEMTECH CORPORATIO	ON	00-847-9941		DUNS	2013-11-04									
Contact Name * Roya Motamedi		Title - Contact QA Customer Servic	e Specialis	Phone - Con 805-389-274	Email - Contact * rmotamedi@semtech.com			om	Duplicate Contact -> Authorized Representative					
Authorized Representati Roya Motamedi		Title - Representative QA Customer Servic		-	resentative * 2		-	entative emtech.c		Supplier Con	ments or UR	L for Add	litional I	nformation
Requester Item Number	r	Mfr Item Number		Mfr Item Name	Effective	Date	Version Manuf China		acturing Site	Weight *	UC	ОМ	Unit Type	
		UClamp2401T.TCT		Low Profile u	Clamp 1-Line ESD					0.787	mg		Each	
Alternate Recommenda	Recommendation							Alternate Item Co		omments				
Manufacturing Proces	ss In	formation												
Terminal Plating / Grid Array I	Materi	al	Terminal Ba	ase Alloy	J-STD-020 MSL Ra	ating P	eak Proc	ess Body	Temper	rature Max Tin	ne at Peak Tem	perature	Number	of Reflow Cycles
Nickel/Palladium/Gold (Ni/Pd/Au) CU Alloy				260 (260 C	;	30 se	econds	3			
UClamp2401T.TCT is RE	EACH	I-compliant product	, per EU R	egulation EC	:1907/2006 to incl	lude rec	ent add	lition of S	SVHC	candidate lis	t of substand	es in Ju	ine 201	3.

Save the fields in this form to a file	Evport Data	Import fields from a file into this form	Import Data	Clear all of the fields on this form	Reset Form	Lock the fields on this form to prevent chan	Look Cupplier Fields
RoHS Materia	Composition Declar	ation				Declaration Type	* Detailed
		ty limit of 0.1% by mass (100 Ethers (PBDE) and quantity					ominated Biphenyls (PBB),
chromium, polybromina excess of an applicable gathered the information Company will rely on thi completing this form, ar certifications regarding conditions of that agree	ted biphenyls and/or polybrominate quantity limit, please indicate below it provides in this form using app s certification in determining the co d that Supplier may not have inde heir contributions to the part, and ment, including any warranty rights	ompliance of its products with European pendently verified such information. Ho those certifications are at least as comp	ricted substance?) in excess believe may apply. If the p y and that such information n Union member state laws owever, in situations where prehensive as the certificati hat agreement, will be the s	ss of the applicable quantity lim part is an assembly with lower I is true and correct to the best of that implement the RoHS Dire Supplier has not independently ion in this paragraph. If the Co sole and exclusive source of the	it identified above. If a homoge evel components, the declaration of its knowledge and belief, as of ctive. Company acknowledges y verified information provided lo popany and the Supplier enter is a Supplier?s liability and the Co	eneous material within the part cor on shall encompass all such comp of the date that Supplier complete: s that Supplier may have relied on by others, Supplier agrees that, at into a written agreement with resp impany?s remedies for issues that	ntains a RoHS restricted substance in ponents. Supplier certifies that it s this form. Supplier acknowledges that information provided by others in a minimum, its suppliers have provided
RoHS Declaration	n * 1 - Item(s) does not conta	ain RoHS restricted substances per the	he definition above			Supplier Acceptance *	Accepted
	e declared item does not co all applicable exemptions.	ntain RoHS restricted substanc	es per the definition a	above except for defined	RoHS exemptions, then	select the corresponding re	esponse in the RoHS Declaration
Declaration S	ignature						
In a family of the second	ward a factor and the factor of the second s	al Calaba and all manages of the last		a second se	• • • • •	and the second s	town - town

Instructions: Complete all of the required fields on all pages of this form. Select the "Accepted" on the Supplier Acceptance drop-down. This will display the signature area. Digitally sign the declaration (if required by the Requester) and click on Submit Form to have the form returned to the Requester.

Supplier Digital Signature

Homogeneous Material Composition Declaration for Electronic Products

Subltem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Substance Instructions: [A] select the Level (JIG A, JIG B, Requester or Supplier) [B] select the substance category (JIG or Requester) or enter a value (Supplier). [C] select the substance (JIG) or enter the substance and CAS (Other). [D] select a RoHS exemption, if applicable [E] enter the weight of the substance or the PPM concentration [F] Optionally enter the positive (+) and negative (-) tolerance in percent (Note: percent tolerance values are expected to cover a 3 sigma range of distribution unless otherwise noted).

Line Functions: +I Inserts a New Item /SubItem +M Inserts a new Material +C Inserts a new Substance Category +S Inserts a new Substance - Deletes the element line

	Item/SubItem				Homogeneous	Weight	Unit of			Level	Substance Category			Substance	CAS	Exempt	Waight	Unit of	Tolerance		РРМ
Name		Name			Material	weight	Measure			Levei	Substance Category			Substance	CAS	Exempt	weight	Measure	-	+	PPIVI
-	-1 -1	Die	+M	і-м	Doped silicon	0.0319	mg	+C	-C	Supplier		+S	-S	Si	7440-21-3		0.0319	mg		4	10,562
	-1 -1	Leadframe	+M	I -м	C7025	0.35859	9mg	+C	-C	Supplier		+S	-S	Cu	7440-50-8		0.3439	mg		4	437,00
					•							+S	-s	Si	7440-21-3		0.0026	mg		:	3,304
								+C	-C	в	Nickel (external applic	+S	-s	Nickel	7440-02-0		0.0115	mg		1	14,582
								+C	-C	Supplier		+S	-s	Mg	7439-95-4		0.0006	mg		7	797
			+M	1-м	Ni/Pd/Au plating	0.00919	5mg	+C	-C	в		+S	-s	Nickel	7440-02-0		0.0083	mg		1	10,536
					•			+C	-C	Supplier	middle plating	+S	-s	Pd	7440-05-3		0.0008	mg		ę	958
								+C	-C	Supplier	outer plating	+S	-s	Au	7440-57-5		0.0001	mg		1	190
•	-1 -1	Bonding wire	+M	I -м	Gold wire	0.0075	mg	+C	-C	Supplier		+S	-s	Au	7440-57-5		0.0075	mg		9	9,549
-	-1 -1	Molding compound	+M	I -м	EME-G770HCD	0.36209	lmg	+C	-C	Supplier		+S	-S	Silica fused	60676-86-0		0.3386	mg		4	430,22
_					•							+S	-s	Epoxy resin	Proprietary		0.0109	mg		1	13,804
												+S	-s	Phenol resin	Proprietary		0.0109	mg		1	13,804
												+S	-s	Carbon Black	1333-86-4		0.0018	mg		2	2,301
•	-1 -1	Die attached Epoxy	+M	I -M	QMI519	0.01761	Smg	+C	-C	Supplier		+S	-s	Ag	7440-22-4		0.0141	mg		1	17,907
					•							+S	-s	palladium compound	Proprietary		0.00003	mg		:	34
												+S	-s	2,6-Di-tert-butyl-p-creso	128-37-0		0.000001	mg		1	1
												+S	-s	Hydroquinone	123-31-9		0.000000	mg		(0.02
												+S	-s	Acrylate	Proprietary		0.0028	mg		:	3,547
												+S	-s	Bismaleimide resin	Proprietary		0.0005	mg		ę	672
												+S	-s	Polymer of polybutadie	Proprietary		0.0002	mg		1	224